

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No
Filing Date 09/03/98
Inventor Farnworth et al.
Assignee Micron Technology, Inc.
Group Art Unit
Examiner Not Assigned
Attorney's Docket No MI22-981
Title: Methods of Bonding Solder Balls to Bond Pads on a Substrate, and Bonding
Frames

POWER OF ATTORNEY BY ASSIGNEE AND CERTIFICATE BY ASSIGNEE UNDER 37 CFR §3.73(b)

To: Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

MICRON TECHNOLOGY, INC., the Assignee of the entire right, title and interest in the above-identified patent application by assignment attached hereto, hereby appoints the attorneys and agents of the firm of WELLS, ST. JOHN, ROBERTS, GREGORY & MATKIN P.S., listed as follows:

Richard J. St. John	Reg.	No.	19,363
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and also attorneys Michael L. Lynch (Reg. No. 30,871) and Lia Pappas Dennison (Reg. No. 34,095) of Micron Technology, Inc., as its attorneys with full power of substitution to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

The Assignee certifies that the above-identified Assignment has been reviewed and to the best of Assignee's knowledge and belief, title is in the Assignee.

Please direct all correspondence regarding this application to:

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MICRON TECHNOLOGY, INC.

Dated: 27,1949 By: 19

Name: Michael L. Lynch, Esq. Title: Chief Patent Counsel